



Specification for Approval

Date: 2016/08/11

Customer: (友人達)

	TAI-TECH P/N:	HPC6045N	F-Series		
	CUSTOMER P/N:				
	DESCRIPTION:				
	QUANTITY:		pcs	_	
DE .	EMARK:				
KE	IWARK:				
	Cu	stomer Approva	al Feedba	ck	
□ 西北臺慶科技股份有限公司 TAI-TECH Advanced Electron Headquarter: NO.1 YOU 4TH ROAD, YOUTH INDUS TAO-YUAN HSIEN, TAIWAN, R.O.C. TEL: +886-3-4641148 FAX: +886-3- http://www.tai-tech.com.tw	STRIAL DISTRICT, YANG-MEI,				
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■ 慶邦電子元器件(泗洪)有限公司

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P1

SMD Power Inductor

		ECN HIS	STORY LIS	Т	
REV	DATE	DESCRIPTION	APPROVED	CHECKED	DRAWN
1.0	16/08/11	新發行	楊祥忠	詹偉特	何秦芝
備					
註					

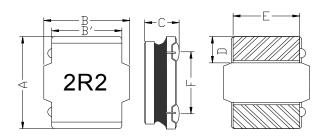
SMD Power Inductor

HPC6045NF-Series

1. Features

- 1. This specification applies Low Profile Power Inductors.
- 2. 100% Lead(Pb) & Halogen-Free and RoHS compliant.

2. Dimension

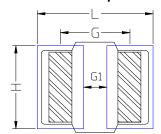


Series	A(mm)	B(mm)	B'(mm)	C(mm)	D(mm)	E(mm)	F(mm)
HPC6045NF	6.0 ± 0.3	6.0±0.3	4.8±0.2	4.2±0.3	1.7±0.3	4.5±0.3	4.25±0.3

Halogen-free



Recommended Land pattern



L(mm)	G(mm)	G1(mm)	H(mm)
6.5	4.25	1.80min	4.8

3. Part Numbering

HPC	6045	NF	-	2R2	Y
Α	В	С		D	Е

A: Series

B: Dimension

A/B*C

C: Type

D: Inductance E: Inductance Tolerance 2R2=2.20uh 100=10uh,101=100uh,102=1000uh

 $M=\pm 20\%, Y=\pm 30\%.$

marking direction cannot decide polarity. Color: Black, unidirectional.

magnetic shielding

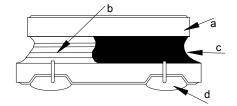
4. Specification

						Rated current				
Part Number	L0 (uH)		Tolerance		•	ure current is (A)		on current t (A)	DCR (mΩ) @25℃	
	@ 0 A	K L		М	Υ	Тур Мах		Тур Мах		±20%.
HPC6045NF-R36	0.36	1	1	±20%	±30%	9.00	8.50	18.00	16.50	4.80
HPC6045NF-R47	0.47	1	1	±20%	±30%	8.60	8.00	17.00	16.00	6.80
HPC6045NF-R82	0.82	1	1	±20%	±30%	8.20	7.50	14.50	13.50	8.50
HPC6045NF-1R0	1.00	1	1	±20%	±30%	8.00	7.30	13.50	12.50	10.0
HPC6045NF-1R2	1.20	1	1	±20%	±30%	7.50	7.00	12.50	11.50	10.5
HPC6045NF-1R3	1.30	1	1	±20%	±30%	7.50	7.00	12.50	11.50	10.5
HPC6045NF-1R5	1.50	1	1	±20%	±30%	7.00	6.60	12.00	11.00	11.7
HPC6045NF-1R8	1.80	1	1	±20%	±30%	6.80	6.20	11.00	10.00	12.0
HPC6045NF-2R0	2.00	1	1	±20%	±30%	6.50	5.80	10.50	9.50	13.5
HPC6045NF-2R2	2.20	1	1	±20%	±30%	6.00	5.30	9.50	8.55	15.0
HPC6045NF-2R3	2.30	1	1	±20%	±30%	5.80	5.00	9.30	8.20	16.0
HPC6045NF-3R0	3.00	1	1	±20%	±30%	5.20	4.60	8.00	7.50	20.0
HPC6045NF-3R3	3.30	1	1	±20%	±30%	5.00	4.50	7.80	7.30	21.0
HPC6045NF-3R6	3.60	1	1	±20%	±30%	4.90	4.30	7.40	6.90	22.5
HPC6045NF-4R7	4.70	1	±15%	±20%	±30%	4.50	4.00	6.80	6.20	26.0
HPC6045NF-5R6	5.60	1	±15%	±20%	±30%	4.10	3.70	6.40	5.70	31.0
HPC6045NF-6R3	6.30	1	±15%	±20%	±30%	3.80	3.50	5.90	5.30	33.0
HPC6045NF-6R8	6.80	1	±15%	±20%	±30%	3.60	3.30	5.70	5.15	34.0
HPC6045NF-8R2	8.20	1	±15%	±20%	±30%	3.40	2.90	5.10	4.50	46.0
HPC6045NF-100	10.0	±10%	±15%	±20%	±30%	3.20	2.60	4.60	4.20	52.0
HPC6045NF-150	15.0	±10%	±15%	±20%	±30%	2.80	2.20	3.80	3.30	71.0
HPC6045NF-180	18.0	±10%	±15%	±20%	±30%	2.60	2.10	3.40	2.90	80.0
HPC6045NF-220	22.0	±10%	±15%	±20%	±30%	2.30	1.90	3.30	2.70	96.0
HPC6045NF-330	33.0	±10%	±15%	±20%	±30%	1.80	1.50	2.50	2.10	145
HPC6045NF-470	47.0	±10%	±15%	±20%	±30%	1.60	1.20	2.00	1.75	200
HPC6045NF-560	56.0	±10%	±15%	±20%	±30%	1.40	1.00	1.80	1.65	230
HPC6045NF-680	68.0	±10%	±15%	±20%	±30%	1.10	0.92	1.60	1.52	305
HPC6045NF-820	82.0	±10%	±15%	±20%	±30%	0.98	0.88	1.50	1.40	365
HPC6045NF-101	100	±10%	±15%	±20%	±30%	0.92	0.82	1.33	1.25	456
HPC6045NF-121	120	±10%	±15%	±20%	±30%	0.85	0.79	1.20	1.10	500
HPC6045NF-151	150	±10%	±15%	±20%	±30%	0.75	0.70	1.10	1.00	626
HPC6045NF-181	180	±10%	±15%	±20%	±30%	0.68	0.60	1.00	0.90	745
HPC6045NF-221	220	±10%	±15%	±20%	±30%	0.60	0.50	0.88	0.77	900
HPC6045NF-331	330	±10%	±15%	±20%	±30%	0.55	0.45	0.60	0.55	1400
HPC6045NF-471	470	±10%	±15%	±20%	±30%	0.40	0.35	0.50	0.45	2050

Note:

- 1. All test data referenced to 25 $^{\circ}\mathrm{C}$ $\,$ ambient , Ls/Q:1MHz/1V.
- 2. Testing Instrument : HP4284A,CH11025,CH3302,CH1320 ,CH1320S LCR METER / Rdc:CH502BC MICRO OHMMETER.
- 3. Heat Rated Current (Irms) will cause the coil temperature rise approximately Δt of 40°C (keep 1min.).
- 4. Saturation Current (Isat) will cause L0 to drop 30% typical. (keep quickly).
- 5. The part temperature (ambient + temp rise) should not exceed 125°Cunder worst case operating conditions. Circuit design, component, PCB trace size and thickness, airflow and other cooling provisions all affect the part temperature. Part temperature should be verified in the end application.
- 6. Special inquiries besides the above common used types can be met on your requirement.

5. Material List



NO	Items	Materials
а	Core	Ferrite Core
b	Wire	Copper Wire
С	Coating	Epoxy with magnetic
d	Solder	Lead free

6. Reliability and Test Condition

Item	Performance	Test Condition
Operating temperature	-40~+125℃(Including self - temperature rise)	
Storage temperature	-40~+125℃ (on board)	
Electrical Performance Test		,
Inductance		HP4284A,CH11025,CH3302,CH1320,CH1320S LCR Meter.
DCR	Refer to standard electrical characteristics list.	CH502BC,Agilent33420A Micro-Ohm Meter.
Saturation Current (Isat)	△L30% typical.	Saturation DC Current (Isat) will cause L0 to drop △L(%)(keep quickly).
Heat Rated Current (Irms)	Approximately △T≤40°C	Heat Rated Current (Irms) will cause the coil temperature rise \(\Delta T(\C) \) without core loss. 1. Applied the allowed DC current(keep 1 min.). 2. Temperature measured by digital surface thermometer
Reliability Test		
Life Test		Preconditioning: Run through IR reflow for 2 times.(IPC/JEDEC J-STD-020DClassification Reflow Profiles) Temperature: 125±2°C (Bead) Temperature: 85±2°C (Inductor) Applied current: rated current Duration: 1000±12hrs Measured at room temperature after placing for 24±2 hrs
Load Humidity	Appearance: No damage. Inductance: within±10% of initial value Q: Shall not exceed the specification value. RDC: within±15% of initial value and shall not exceed the specification value	Preconditioning: Run through IR reflow for 2 times.(IPC/JEDEC J-STD-020DClassification Reflow Profiles Humidity: 85±2% R.H, Temperature: 85°C±2°C Duration: 1000hrs Min. with 100% rated current Measured at room temperature after placing for 24±2 hrs
Thermal shock		Preconditioning: Run through IR reflow for 2 times.(IPC/JEDEC J-STD-020DClassification Reflow Profiles Condition for 1 cycle Step1: -4042°C 30±5min Step2: 25±2°C ≤0.5min Step3: 105±2°C 30±5min Number of cycles: 500 Measured at room temperature after placing for 24±2 hrs
Vibration		Oscillation Frequency: 10~2K~10Hz for 20 minutes Equipment: Vibration checker Total Amplitude:1.52mm±10% Testing Time: 12 hours(20 minutes, 12 cycles each of 3 orientations) •
Shock		Peak Normal Wave Velocity Type value duration (D) form change
Bending		G G G G G G G G G G

Item	Performance	Test Method and Remarks
	More than 95% of the terminal electrode should be covered with solder $^{\circ}$	Preheat: 150°C,60sec. ∘ Solder: Sn99.5%-Cu0.5% ∘ Temperature: 245±5°c ∘ Flux for lead free: Rosin. 9.5% ∘ Dip time: 4±1sec ∘

		Depth: completely cover the termination
		Number of heat cycles: 1
Resistance to Soldering		Temperature (°C) Time(s) Temperature ramp/immersion and emersion rate
Heat		260 ±5(solder temp) 10 ±1 25mm/s ±6 mm/s
Terminal Strength	Appearance: No damage. Inductance: within±10% of initial value Q: Shall not exceed the specification value. RDC: within ±15% of initial value and shall not exceed the specification value	Preconditioning: Run through IR reflow for 2 times.(IPC/JEDEC J-STD-020DClassification Reflow Profiles With the component mounted on a PCB with the device to be tested, apply a force (>0805:1kg, <=0805:0.5kg)to the side of a device being tested. This force shall be applied for 60 +1 seconds. Also the force shall be applied gradually as not to apply a shock to the component being tested.

7. Soldering and Mounting

(1) Soldering

Mildly activated rosin fluxes are preferred. The minimum amount of solder can lead to damage from the stresses caused by the difference in coefficients of expansion between solder, chip and substrate. TAI-TECH terminations are suitable for re-flow soldering systems. If hand soldering cannot be avoided, the preferred technique is the utilization of hot air soldering tools.

(2) Solder re-flow:

Recommended temperature profiles for re-flow soldering in Figure 1.

(3) Soldering Iron:

Products attachment with a soldering iron is discouraged due to the inherent process control limitations. In the event that a soldering iron must be employed the following precautions are recommended.

- Preheat circuit and products to 150℃
- · Never contact the ceramic with the iron tip
- Use a 20 watt soldering iron with tip diameter of 1.0mm
- 355°C tip temperature (max) • 1.0mm tip diameter (max)
- · Limit soldering time to 4~5sec.

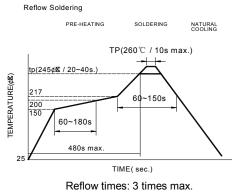
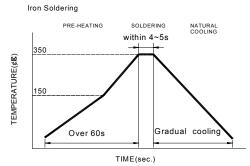


Fig.1



Iron Soldering times: 1 times max.

Fig.2

8. Packaging Information

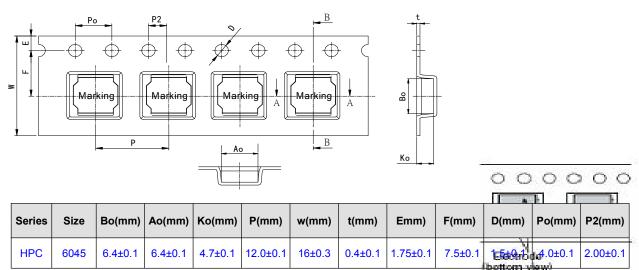
(1) Reel Dimension





Туре	A(mm)	B(mm)	C(mm)	D(mm)
13"x16mm	16.5±0.5	80±2.0	13.5±0.5	330±3.0

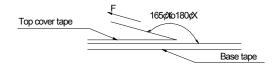
(2) Tape Dimension



(3) Packaging Quantity

НРС	6045
Reel	1000
Inner box	2000
Carton	8000

(4) Tearing Off Force



The force for tearing off cover tape is 10 to 130 grams in the arrow direction under the following conditions(referenced ANSI/EIA-481-C-2003 of 4.11 stadnard).

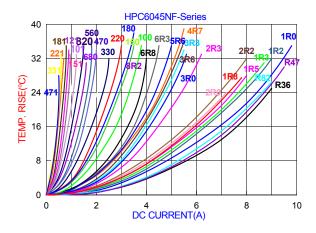
Room Temp. (°C)	Room Humidity (%)	Room atm (hPa)	Tearing Speed mm/min
5~35	45~85	860~1060	300

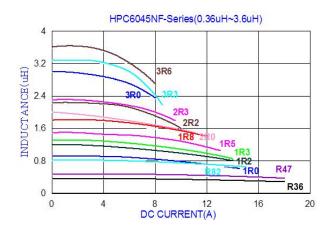
Application Notice

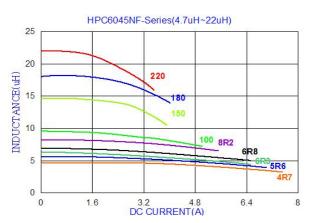
- · Storage Conditions (component level)
 - To maintain the solderability of terminal electrodes:
 - 1. TAI-TECH products meet IPC/JEDEC J-STD-020D standard-MSL, level 1.

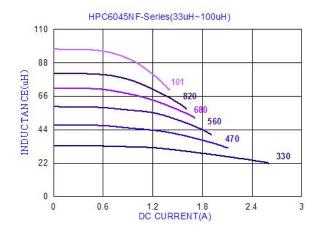
 - 3. Recommended products should be used within 12 months form the time of delivery.
 - 4. The packaging material should be kept where no chlorine or sulfur exists in the air.
- Transportation
 - 1. Products should be handled with care to avoid damage or contamination from perspiration and skin oils.
- 2. The use of tweezers or vacuum pick up is strongly recommended for individual components.
- 3. Bulk handling should ensure that abrasion and mechanical shock are minimized.

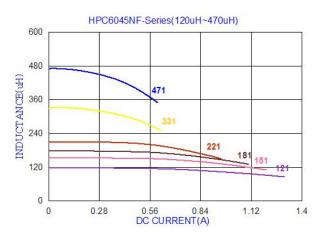
9. Typical Performance Curves





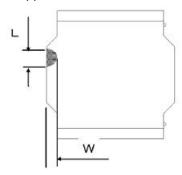






Core chipping

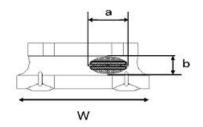
The appearance standard of the chipping size on top side, and bottom side ferrite core is listed below.





Void appearance tolerance Limit

Size of voids occurring to coating resin is specified below.

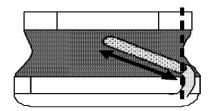


Exposed wire tolerance limit of coating resin part on product side.

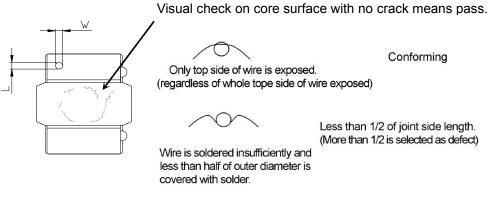
Size of exposed wire occurring to coating resin is specified below.

- 1. Width direction (dimension a): Acceptable when $a \le w/2$.
- 2. Length direction (dimension b): Dimension b is not specified.
- 3. The total area of exposed wire occurring to each sides is not greater than 50% of coating resin area, and is acceptable.

External appearance criterion for exposed wire Exposed end of the winding wire at the secondary side should be 3mm and below.



Electrode appearance criterion for exposed wire



L	W	
1.5mm Max.	1.5mm Max.	

Electrodes with foreign body (dirt) appearance standards
Foreign materials (dirt) will not affect the coplanarity of PAD,
below the example of foreign materials (dirt) quantity ≤2PCS on single PAD.
dimension range as below.

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